

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

INFORMATION DISCLOSURE STATEMENT

Sir:

In accordance with MPEP 609 and 37 C.F.R. §§ 1.56, 1.97 and 1.98, Applicants bring the references listed on the attached PTO-1449-Form to the Examiner's attention and request that they be considered and made of record in this application. Copies of the non-U.S. patents are attached.

Japanese Laid Open Publication No. 62-57038 appears to disclose a heat pump air conditioner.

Japanese Patent Publication No. 62-276368 appears to disclose an oil tempering mechanism for an air conditioner.

Japanese Patent Publication No. 63-204074 appears to disclose a refrigerating apparatus having a vapor compression-type refrigerant circuit.

Japanese Patent Publication No. 03-036474 appears to disclose a multi-type air conditioner having plural indoor units. An English abstract is attached to better understand this publication.

Japanese Patent Publication No. 03-129259 appears to disclose a multi-room type air conditioner. An English abstract is attached to better understand this publication.


Japanese Patent Application No. 03-260561 appears to disclose an air conditioner having a pressurizing circuit. An English abstract is attached to better understand this publication.

Japanese Laid Open Publication No 04-74257 appears to disclose a refrigerating apparatus having a hot gas bypass circuit.

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Prompt examination on the merits is respectfully requested.

Respectfully submitted,


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Dated: July 19, 2006

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